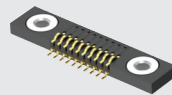
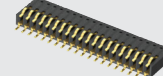




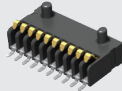
SEI-110-02-GF-S-E-TR



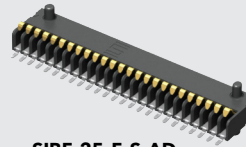
SEI-120-02-GF-S



SIBF-10-F-S-AD



SIBF-25-F-S-AD



SIBF-05-F-S-AD



(1.00 mm) .0394" (SEI) (1.27 mm) .050" (SIBF)

SEI, SIBF SERIES

ONE-PIECE INTERFACE

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SEI or see www.samtec.com?SIBF

Insulator Material:

SEI = Liquid Crystal Polymer
SIBF = Black Liquid Crystal Polymer

Contact Material:

Phosphor Bronze

Plating:

SEI = Au over
50 μ " (1.27 μ m) Ni
SIBF = Au or Sn over
50 μ " (1.27 μ m) Ni

Current Rating:

SEI = 2.3 A per pin
(1 pin powered)
SIBF = 2.5 A per pin
(1 pin powered)

Operating Temp Range:

-55 °C to +125 °C

Mating Force:

SEI = 50 g (0.49 N) per contact

Voltage Rating:

SEI = 250 VAC/354 VDC
SIBF = 155 VAC/219 VDC

Cycles:

SEI = 100 min

Contact Deflection:

SEI = (0.46 mm) .018" nominal

RoHS Compliant:

Yes

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity (SEI):

(0.10 mm) .004" max (05-25)

(0.15 mm) .006" max (30)*

*(.004" stencil solution may be available; contact ipg@samtec.com)

SMT Lead Coplanarity (SIBF):

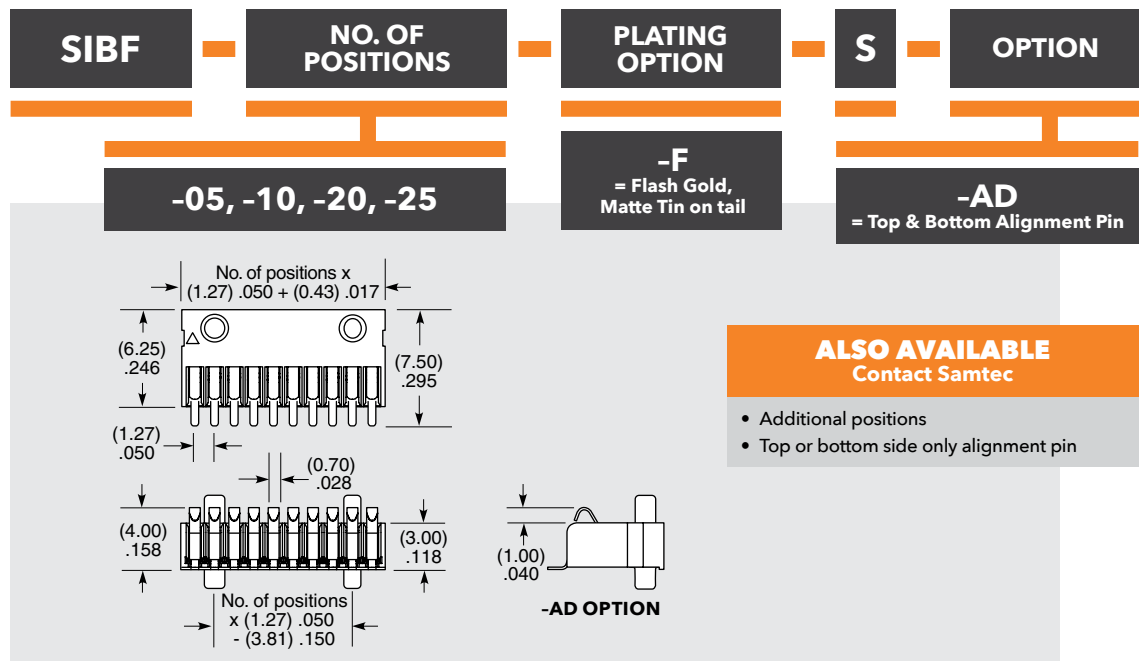
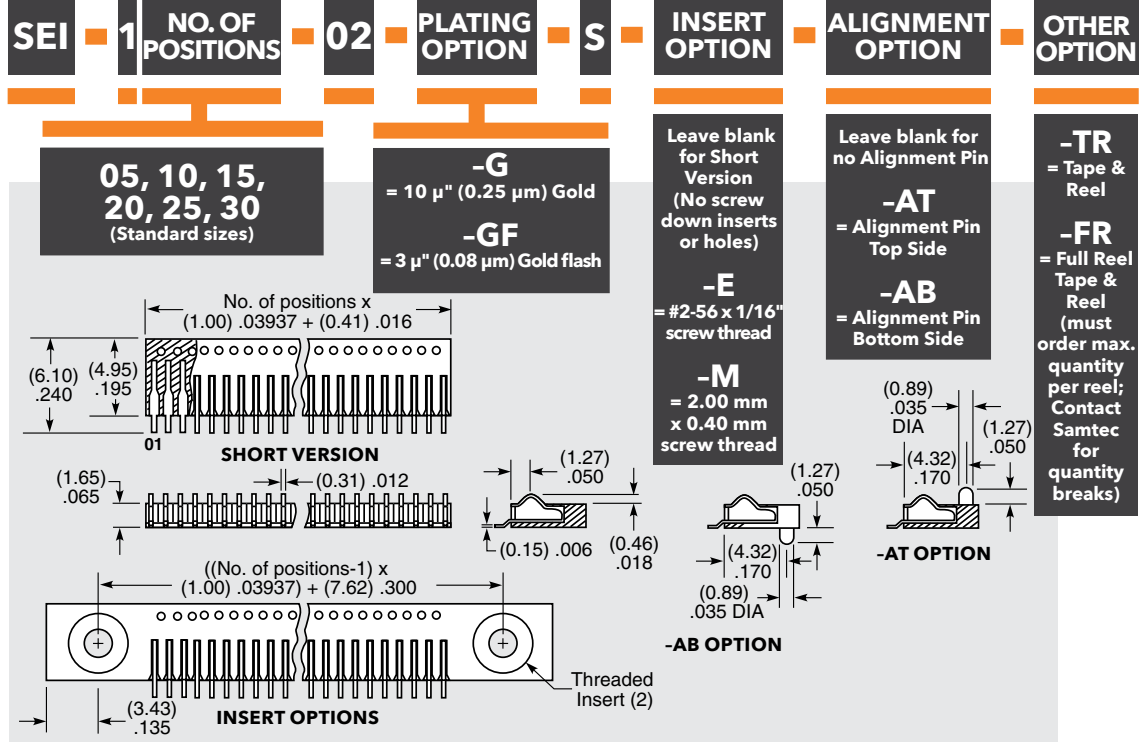
(0.10 mm) .004" max (05-20)

(0.15 mm) .006" max (25)*

*(.004" stencil solution may be available; contact ipg@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE
Contact Samtec

- Additional positions
- Top or bottom side only alignment pin